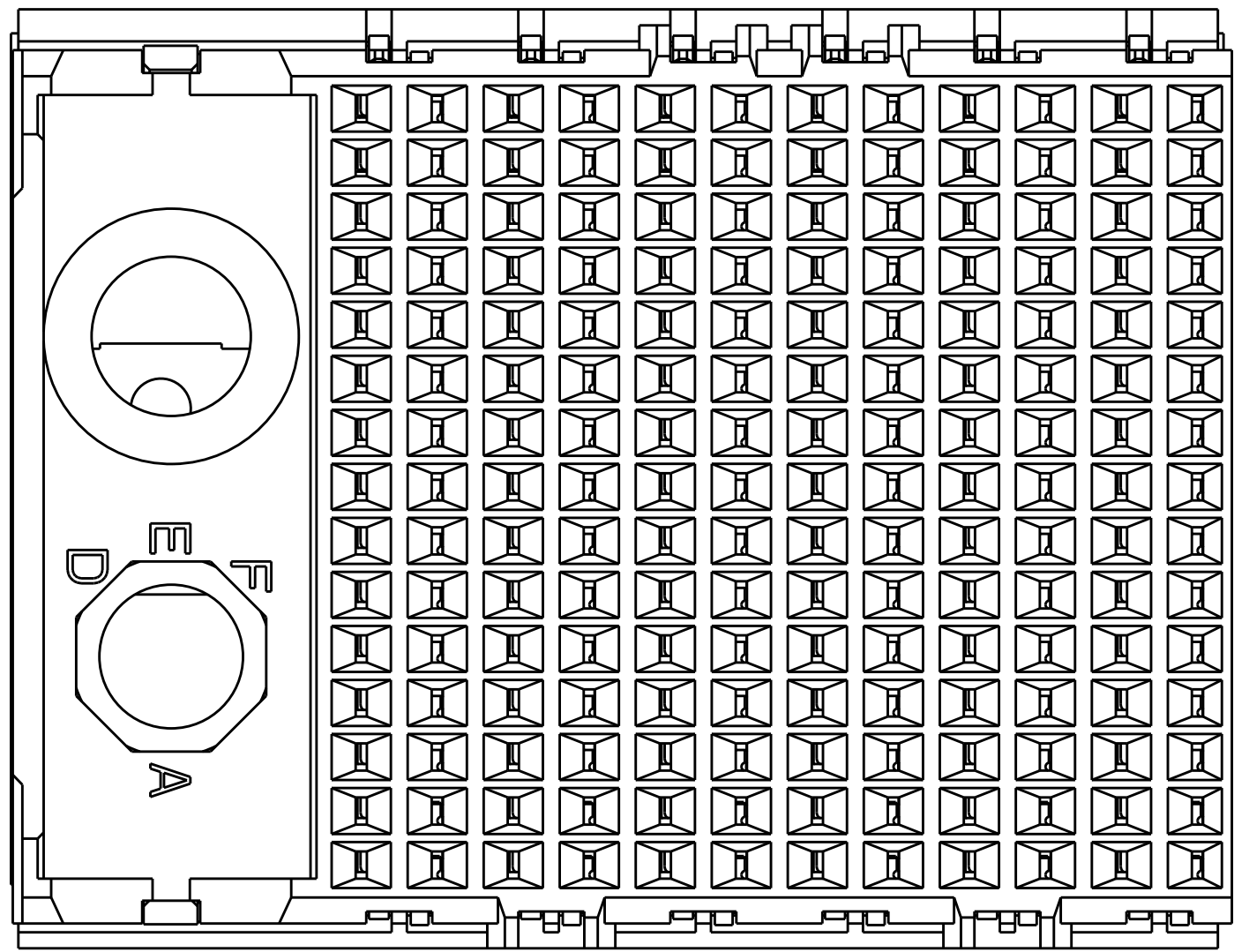
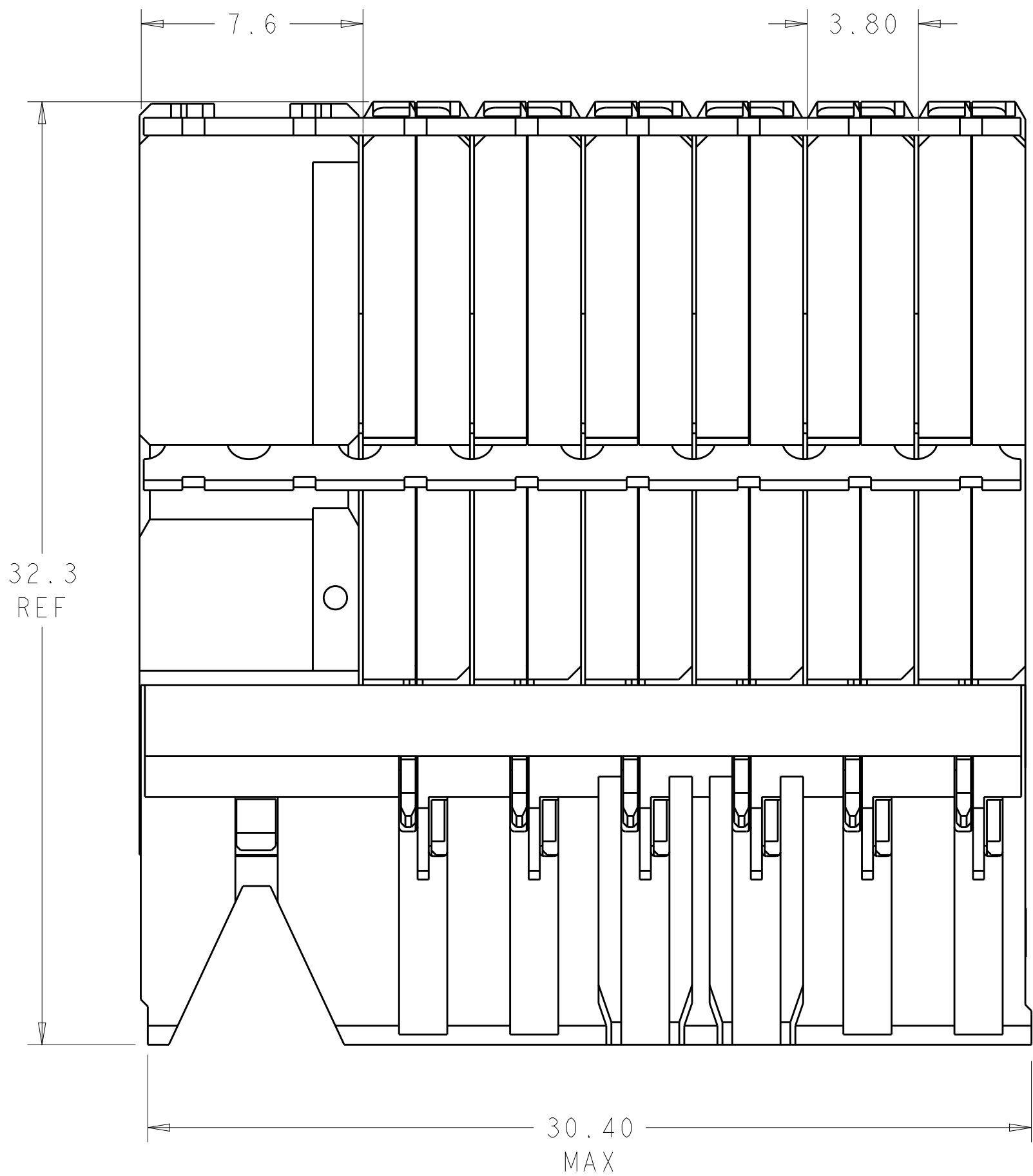


D

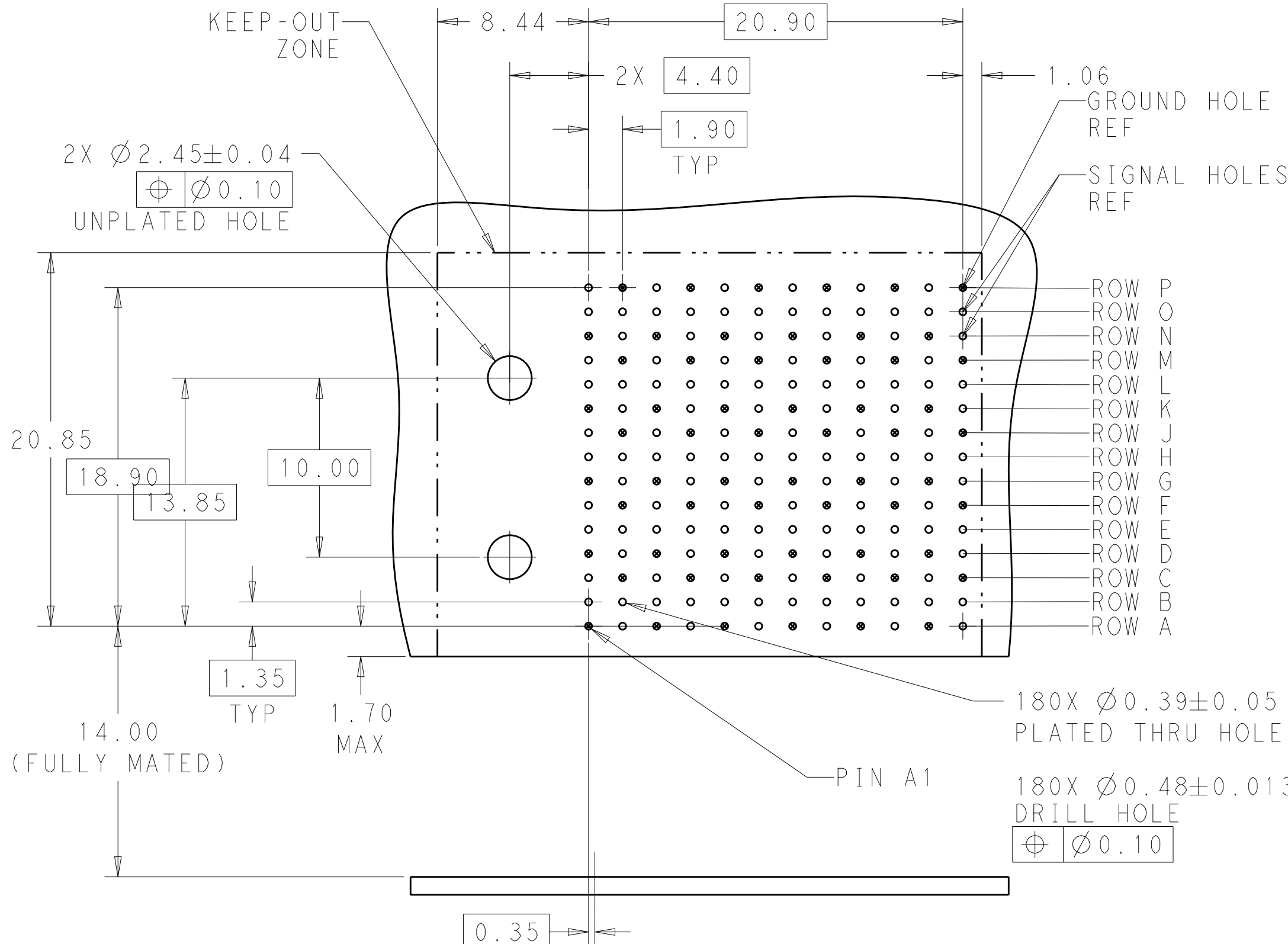
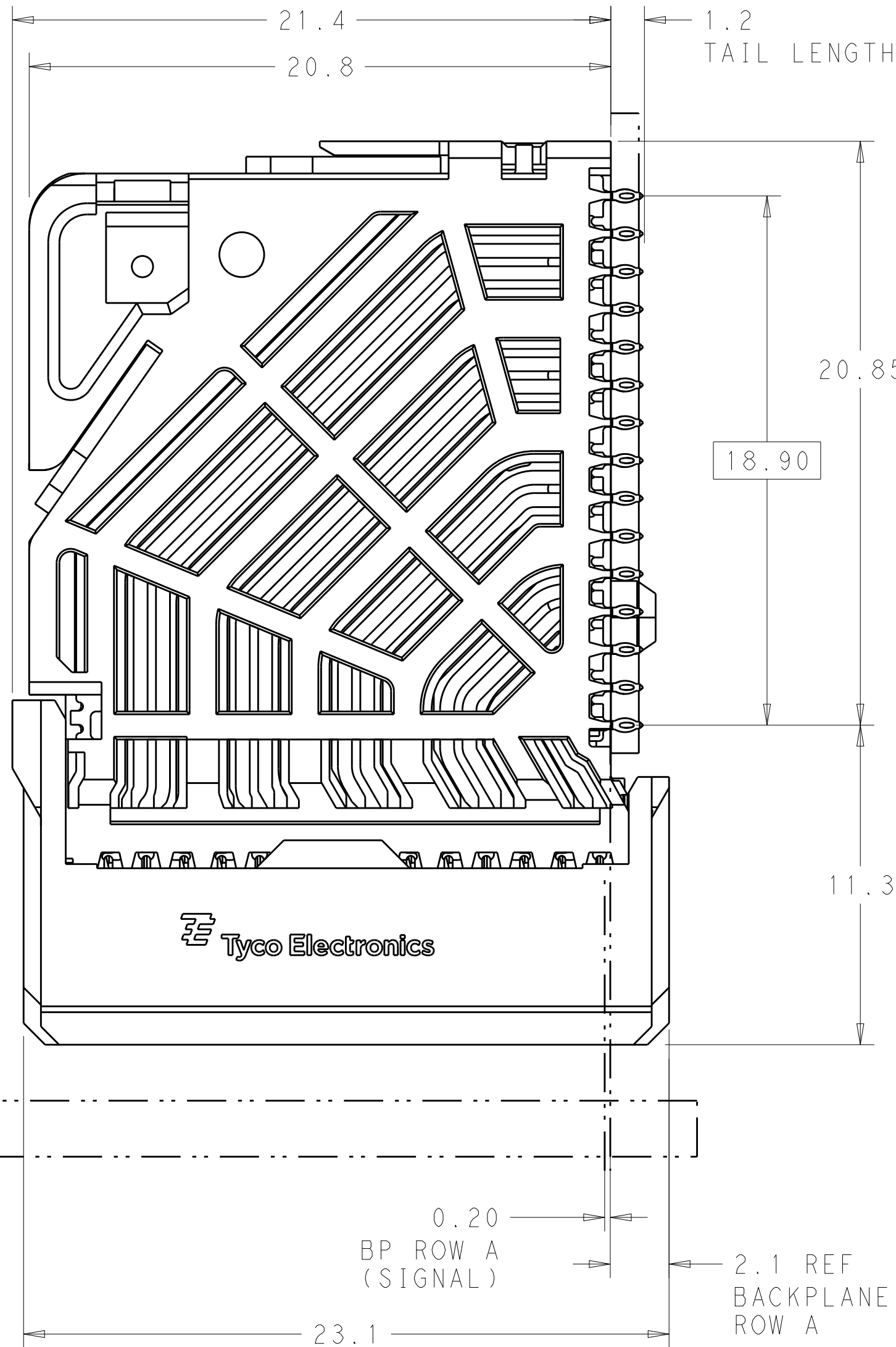
C

B

A



KEY POSITION CHART			
NONE			
A	E		
B	F		
C	G		
D	H		

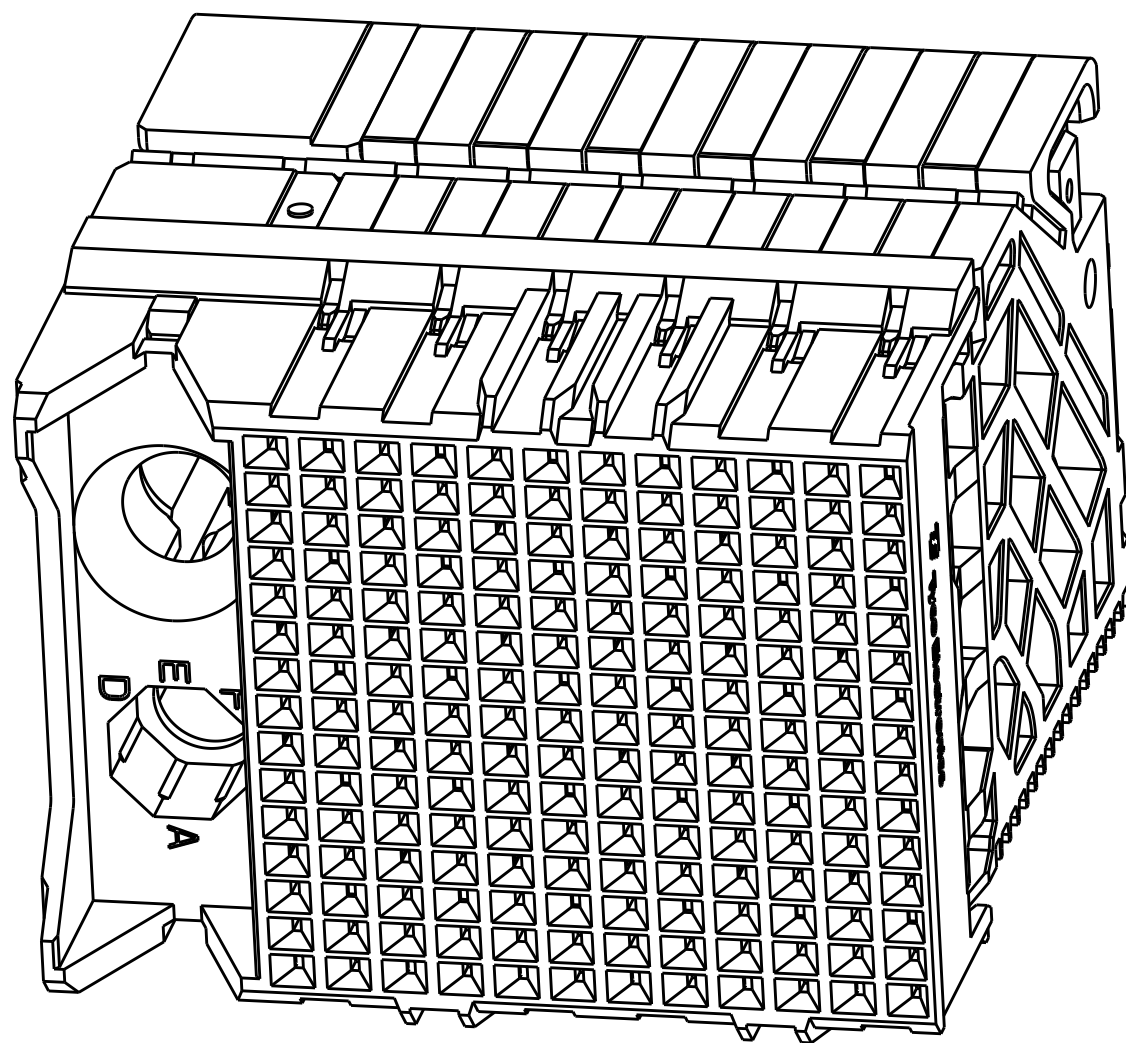


OFFSET BETWEEN BOARD AND
BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

REVISIONS					
P	LYR	DESCRIPTION	DATE	DWN	APVD
	B2	REVISED PER ECO-15-004915	09APR2015	AP	DD

- 1 MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- 2 FINISH:
30 μ " SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN
ON PCB TAILS, NICKEL OVERALL.
3. CONNECTORS SUPPLIED WITH MOUNTING SCREWS.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY

H	2	8-2110110-1
G	2	7-2110110-1
F	2	6-2110110-1
E	2	5-2110110-1
D	2	4-2110110-1
C	2	3-2110110-1
B	2	2-2110110-1
A	2	1-2110110-1
NONE	2	2110110-1
KEY POSITION		PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 07JUL2011	 TE Connectivity	
		CHK D. DIXON 07JUL2011		
DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED:		NAME
		0 PLC ±.2 1 PLC ±0.13 2 PLC ±.13 3 PLC ±. 4 PLC ±. ANGLES ±.		
MATERIAL		FINISH SEE TABLE		SIZE CAGE CODE DRAWING NO
		WEIGHT -		
CUSTOMER DRAWING		A100779C=2110110	RESTRICTED TO	
		SCALE 6:1 SHEET 1 OF 1		
		REV B2		